74HC4520; 74HCT4520

Dual 4-bit synchronous binary counter

Rev. 6 — 9 October 2020

Product data sheet

1. General description

The 74HC4520; 74HCT4520 are dual 4-bit internally synchronous binary counters with two clock inputs (nCP0 and n $\overline{CP1}$). They have buffered outputs from all 4 bit positions (nQ0 to nQ3) and an asynchronous master reset input (nMR). The counter advances on the LOW-to-HIGH transition of nCP0 when n $\overline{CP1}$ is HIGH. It also advances on the HIGH-to-LOW transition of n $\overline{CP1}$ when nCP0 is LOW. Either nCP0 or n $\overline{CP1}$ may be used as the clock input to the counter. The other clock input may be used as a clock enable input. A HIGH on nMR, resets the counter (nQ0 to nQ3 = LOW) independent of nCP0 and n $\overline{CP1}$. Inputs include clamp diodes. It enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Input levels:
 - For 74HC4520: CMOS level
 - For 74HCT4520: TTL level
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Applications

- · Multistage synchronous counting
- · Multistage asynchronous counting
- Frequency dividers

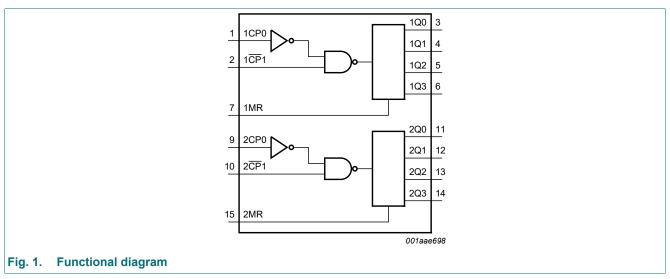
4. Ordering information

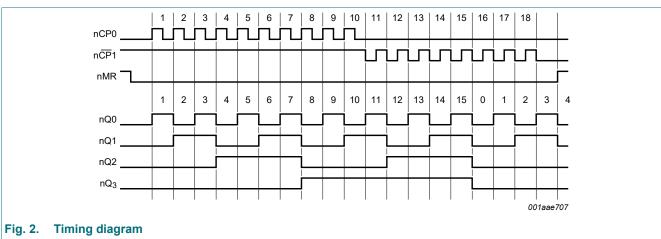
Table 1. Ordering information

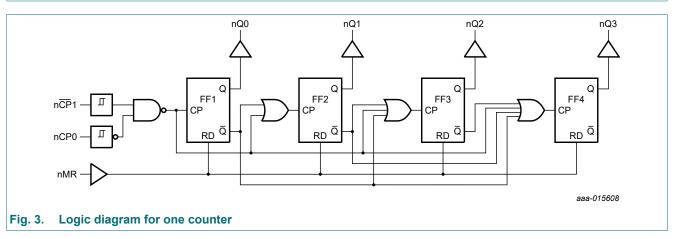
Type number	Package							
	Temperature range	Name	Description	Version				
74HC4520D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1				
74HCT4520D			body width 3.9 mm					
74HC4520PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1				



5. Functional diagram

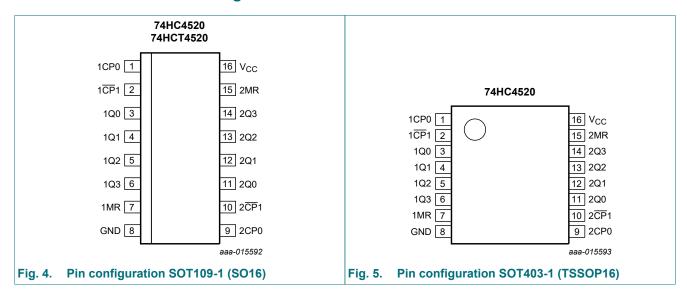






6. Pinning information

6.1. Pinning



6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP0, 2CP0	1, 9	clock input (LOW-to-HIGH edge-triggered)
1 <u>CP</u> 1, 2 <u>CP</u> 1	2, 10	clock input (HIGH-to-LOW edge-triggered)
1Q0 to 1Q3	3, 4, 5, 6	output
1MR, 2MR	7, 15	asynchronous master reset input (active HIGH)
GND	8	ground (0 V)
2Q0 to 2Q3	11, 12, 13, 14	output
V _{CC}	16	supply voltage

7. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = positive-going \ transition; \ \downarrow = negative-going \ transition.$

nCP0	nCP1	nMR	Mode
↑	Н	L	counter advances
L	\downarrow	L	counter advances
\	X	L	no change
X	\uparrow	L	no change
↑	L	L	no change
Н	<u></u>	L	no change
Х	X	Н	nQ0 to nQ3 = LOW

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

^[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC4520			74HCT4520			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HC45	20									
V _{IH} HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V	
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to !5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	٧
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	٧
		I _O = -4.0; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	٧
		I _O = -5.2; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	٧
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	٧
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	٧
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	٧
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80.0	-	160.0	μA
C _I	input capacitance			3.5	-	-	-	-	-	pF
74HCT4	520		1							
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	8.0	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	Ι _Ο = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	٧
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80.0	-	160.0	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V ; $I_O = 0 \text{ A}$								
		pin nCP0, nCP1	-	80	288	-	360	-	392	μA
		pin nMR	-	150	540	-	675	-	735	μA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 8.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
74HC45	20									
t _{pd}	propagation	nCP0 to nQn; see Fig. 6	[1]							
	delay	V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns
		nCP1 to nQn; see Fig. 6	[1]							
		V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns
t _{PHL}	HIGH to LOW	nMR to nQn; see Fig. 6								
	propagation	V _{CC} = 2.0 V	-	44	150	-	190	-	225	ns
	delay	V _{CC} = 4.5 V	-	16	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	13	26	-	33	-	38	ns
t _t transition time	nQn; see Fig. 6	[2]								
	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns	
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	nCP0, nCP1 HIGH or LOW; see Fig. 7								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nMR HIGH; see Fig. 7								
		V _{CC} = 2.0 V	120	39	-	150	-	180	-	ns
		V _{CC} = 4.5 V	24	14	-	30	-	36	-	ns
		V _{CC} = 6.0 V	20	11	-	26	-	31	-	ns
t _{rec}	recovery time	nMR to nCP0, nCP1; see Fig. 7								
		V _{CC} = 2.0 V	0	-28	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-10	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-8	-	0	-	0	-	ns
t _{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see Fig. 6								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	4	-	17	-	20	-	ns

Symbol	Parameter	Conditions		25 °C			°C to		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
f _{max}	maximum	nCP0, nCP1; see Fig. 7								
	frequency	V _{CC} = 2.0 V	6	19	-	4.8	-	4	-	MHz
		V _{CC} = 4.5 V	30	58	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	68	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	69	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}; V_{CC} = 5 \text{ V};$ [3] $f_i = 1 \text{ MHz}$	-	29	-	-	-	-	-	pF
74HCT4	520									
t _{pd}	propagation	nCP0 to nQn; see Fig. 6 [1]								
	delay	V _{CC} = 4.5 V	-	28	53	-	66	-	80	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
		nCP1 to nQn; see Fig. 6 [1]								
		V _{CC} = 4.5 V	-	25	53	-	66	-	80	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	24	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	nMR to nQn; see Fig. 6								
	propagation delay	V _{CC} = 4.5 V	-	16	35	-	44	-	53	ns
	delay	V _{CC} = 5.0 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
t _t	transition	nQn; see Fig. 6 [2]								
	time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _W	pulse width	nCP0, nCP1 HIGH or LOW; see Fig. 7								
		V _{CC} = 4.5 V	20	10	-	25	-	30	-	ns
		nMR HIGH; see Fig. 7								
		V _{CC} = 4.5 V	20	12	-	25	-	30	-	ns
t _{rec}	recovery time	nMR to nCP0, nCP1; see Fig. 7								
		V _{CC} = 4.5 V	0	-8	-	0	-	0	-	ns
t _{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see Fig. 6								
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
f _{max}	maximum	nCP0, nCP1; see Fig. 7								
	frequency	V _{CC} = 4.5 V	30	58	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	64	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}; V_{CC} = 5 \text{ V}; [3]$ $f_i = 1 \text{ MHz}$	-	24	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH}.
 [2] t_t is the same as t_{THL} and t_{TLH}.
 [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
 P_D = C_{PD} × V_{CC}² × f_i × N + Σ(C_L × V_{CC}² × f_o) where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

11.1. Waveforms and test circuit

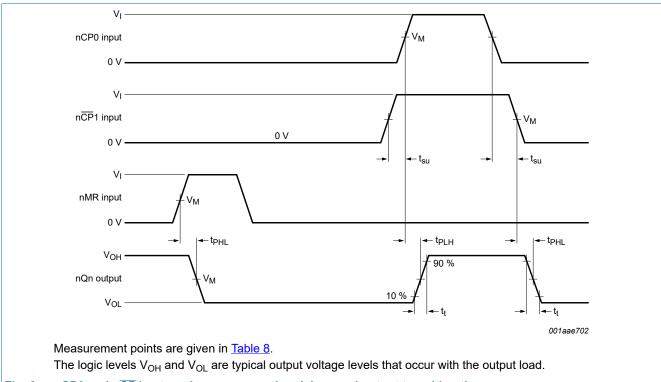


Fig. 6. nCP0 and nCP1 set-up times, propagation delays and output transition times

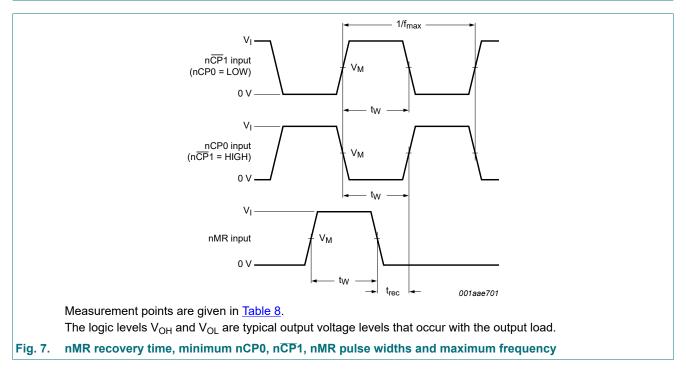
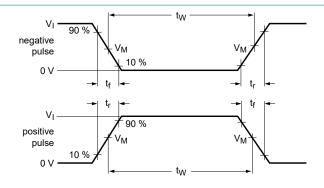
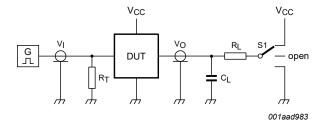


Table 8. Measurement points

rable of Measurement points	·		
Туре	Input	Output	
	V_{M}	V _I	V _M
74HC4520	0.5 × V _{CC}	GND to V _{CC}	0.5 × V _{CC}
74HCT4520	1.3 V	GND to 3 V	1.3 V

74HC_HCT4520





Test data is given in Table 9.

Test circuit definitions:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator

C_L = Load capacitance including jig and probe capacitance

R_L = Load resistance.

S1 = Test selection switch

Fig. 8. Test circuit for measuring switching times

Table 9. Test data

Type Input			Load	S1 position	
	V _I	t _r , t _f	C _L	R_L	t _{PHL} , t _{PLH}
74HC4520	GND to V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT4520	GND to 3 V	6 ns	15 pF, 50 pF	1 kΩ	open

12. Package outline

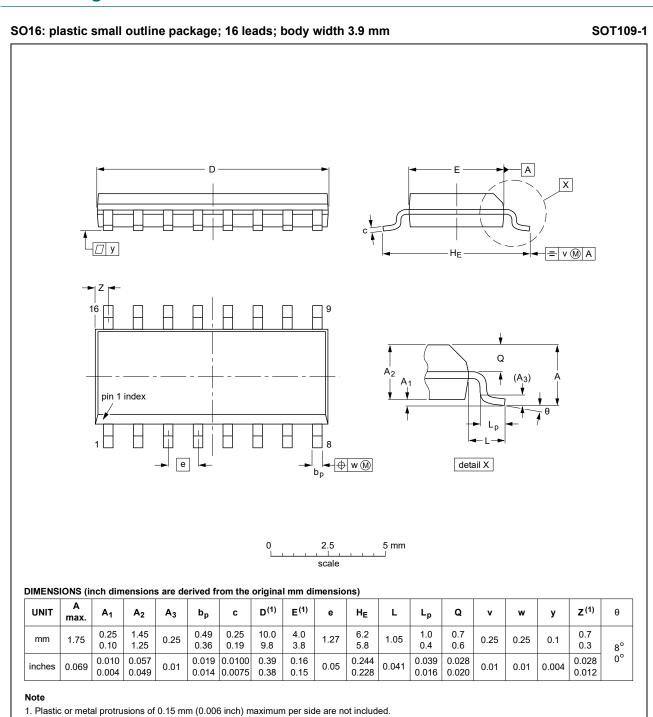


Fig. 9. Package outline SOT109-1 (SO16)

IEC

076E07

OUTLINE

VERSION

SOT109-1

JEITA

REFERENCES

JEDEC

MS-012

ISSUE DATE

99-12-27

03-02-19

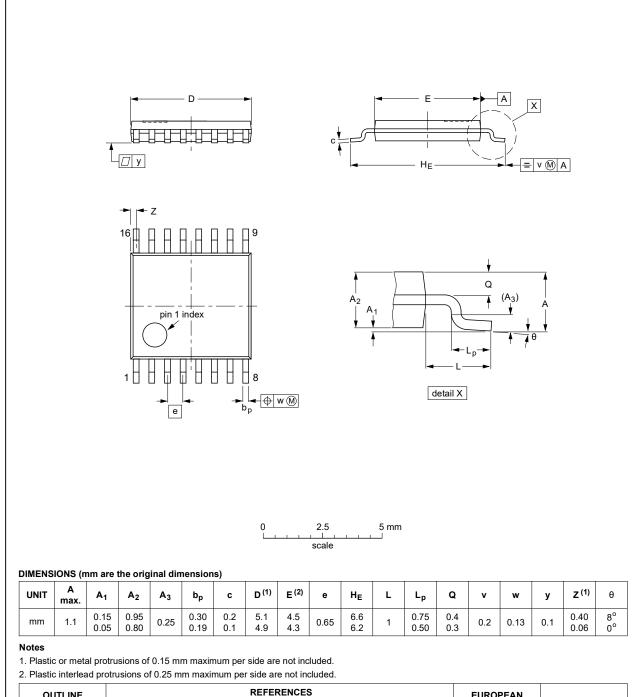
EUROPEAN

PROJECTION

 \square

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT403-1		MO-153			99-12-27 03-02-18

Fig. 10. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT4520 v.6	20201009	Product data sheet	-	74HC_HCT4520 v.5	
Modifications:	 Section 2 updated. Table 4: Derating values for P_{tot} total power dissipation have been updated. 				
74HC_HCT4520 v.5	20190214	Product data sheet	-	74HC_HCT4520 v.4	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type numbers 74HC4520DB and 74HCT4520DB (SOT338-1) removed. 				
74HC_HCT4520 v.4	20160510	Product data sheet	-	74HC_HCT4520 v.3	
Modifications:	Type numbers 74HC4520N and 74HCT4520N (SOT38-4) removed.				
74HC_HCT4520 v.3	20141204	Product data sheet	-	74HC_HCT4520_CNV v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 				
74HC_HCT4520_CNV v.2	19930927	Product specification	-	-	

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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